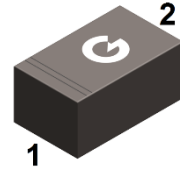


Features

- Tight voltage tolerance: $\pm 2\%$
- Ultra low-profile package well suited for automated assembly
- Moisture sensitivity level 1
- RoHS compliant with Halogen-free
- Qualified to AEC-Q101 Standards

HF



DFN1006-2

Mechanical Data

- Case: DFN1006-2
- Molding Compound: UL Flammability Classification Rating 94V-0
- Terminals: Matte tin-plated leads; solderability-per MIL-STD-202, Method 208

Ordering Information

Part Number	Package	Shipping Quantity	Marking Code
TBZT52B22L	DFN1006-2	10000 pcs / Tape & Reel	P5

Thermal Characteristics

Parameter	Symbol	Value	Unit
Power Dissipation	P_D	100	mW
Thermal Resistance Junction-to-Air	$R_{\theta JA}$	1250	$^{\circ}\text{C/W}$
Operating Junction Temperature Range	T_J	-55 ~ +150	$^{\circ}\text{C}$
Storage Temperature Range	T_{STG}	-65 ~ +150	$^{\circ}\text{C}$

Electrical Characteristics (@ $T_A = 25^{\circ}\text{C}$ unless otherwise specified)

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Zener Voltage	V_Z	$I_{ZT} = 5\text{mA}$	21.56	22.00	22.44	V
Forward Voltage	V_F	$I_F = 10\text{mA}$	-	-	0.9	V
Maximum Reverse Current	I_R	$V_R = 15.4\text{V}$	-	-	0.045	μA
Maximum Zener Impedance	Z_{ZT}	$I_{ZT} = 5\text{mA}$	-	-	55	Ω
Maximum Zener Impedance	Z_{ZK}	$I_{ZK} = 1\text{mA}$	-	-	235	Ω
Temperature Coefficient	T_C	$I_{ZT} = 5\text{mA}$	16.4	18.0	20.0	$\text{mV}/^{\circ}\text{C}$

TYPICAL CHARACTERISTICS (@ $T_A = 25^\circ\text{C}$ unless otherwise specified)

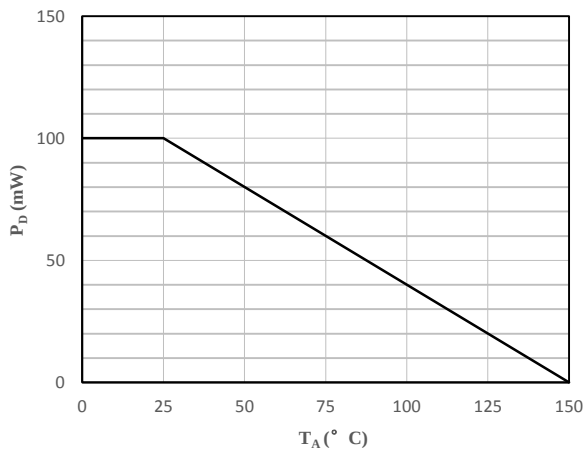


Fig 1 Steady State Power Derating

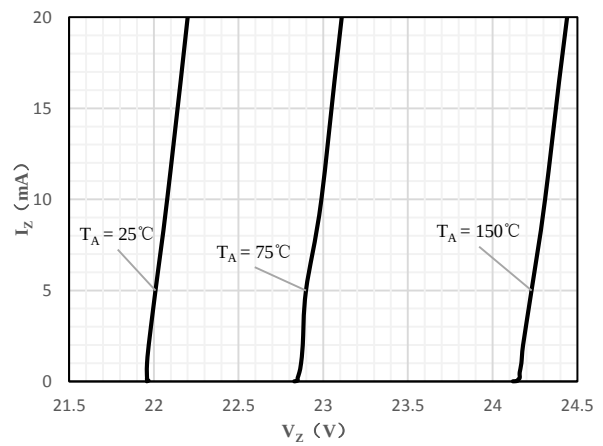


Fig 2 Typical Zener Breakdown Characteristics

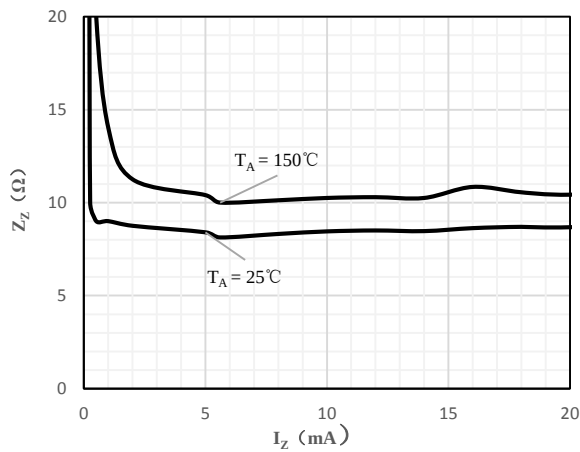


Fig 3 Zener Impedance vs. Zener Current

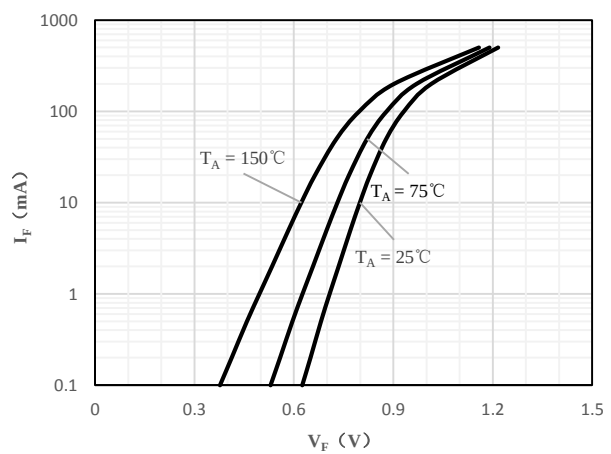


Fig 4 Typical Forward Characteristics

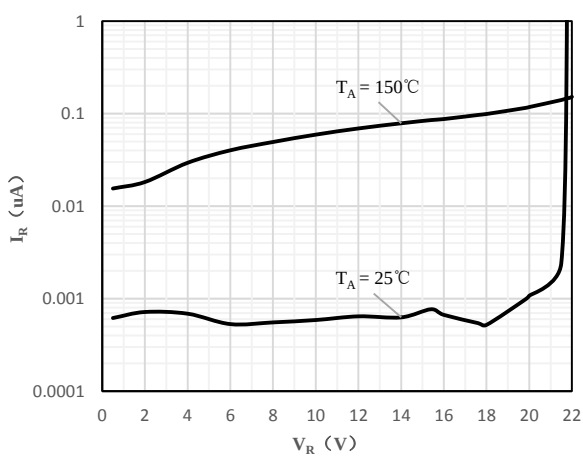
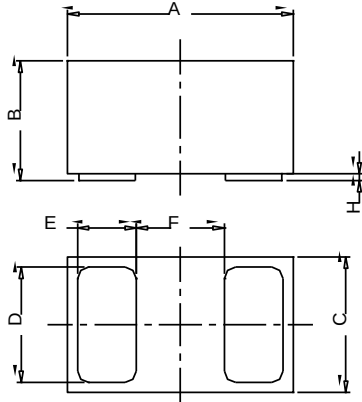


Fig 5 Typical Reverse Characteristics

Package Outline Dimensions (Unit: mm)



DFN1006-2			
Dimension	Min.	Typ.	Max.
A	0.95	1.00	1.075
B	0.45	0.50	0.55
C	0.55	0.60	0.675
D	0.45	0.50	0.55
E	0.20	0.25	0.30
F	-	0.40	-
H	0	0.03	0.05

Package Outline Dimensions (Unit: mm)

DFN1006-2

